



JMSH1507AEQ

## 150V 5.2mΩ N-Ch Power MOSFET

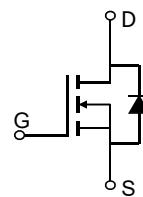
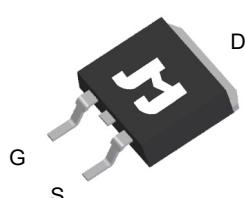
### Features

- Ultra-low ON-resistance,  $R_{DS(ON)}$
- Low Gate Charge,  $Q_g$
- 100% UIS and  $R_g$  Tested
- Pb-free Lead Plating
- Halogen-free and RoHS-compliant
- AEC-Q101 Qualified for Automotive Applications

### Product Summary

| Parameter                             | Value | Unit |
|---------------------------------------|-------|------|
| $V_{DS}$                              | 150   | V    |
| $V_{GS(th)}_{Typ}$                    | 3.2   | V    |
| $I_D (@ V_{GS} = 10V)$ <sup>(1)</sup> | 161   | A    |
| $R_{DS(ON)}_{Typ} (@ V_{GS} = 10V)$   | 5.2   | mΩ   |

TO263-3L Top View

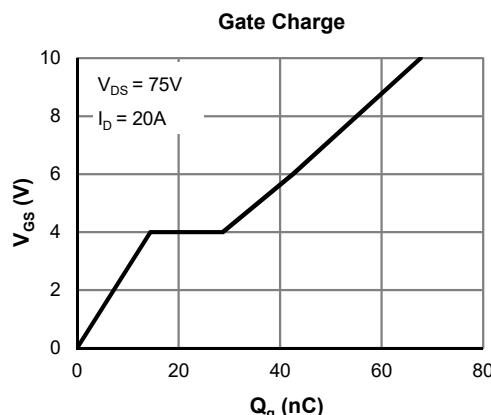
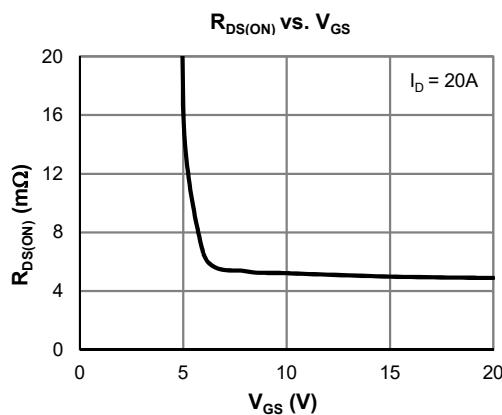


### Ordering Information

| Device         | Package   | # of Pins | Marking  | MSL | $T_J$ (°C) | Media        | Quantity (pcs) |
|----------------|-----------|-----------|----------|-----|------------|--------------|----------------|
| JMSH1507AEQ-13 | TO-263-3L | 3         | SH1507AQ | 1   | -55 to 175 | 13-inch Reel | 800            |

### Absolute Maximum Ratings (@ $T_A = 25^\circ\text{C}$ unless otherwise specified)

| Parameter                               | Symbol         | Value      | Unit |
|---|----------------|------------|------|
| Drain-to-Source Voltage                 | $V_{DS}$       | 150        | V    |
| Gate-to-Source Voltage                  | $V_{GS}$       | $\pm 20$   | V    |
| Continuous Drain Current <sup>(1)</sup> | $I_D$          | 161        | A    |
| $T_C = 100^\circ\text{C}$               |                | 114        |      |
| Pulsed Drain Current <sup>(2)</sup>     | $I_{DM}$       | 600        | A    |
| Avalanche Current <sup>(3)</sup>        | $I_{AS}$       | 60         | A    |
| Avalanche Energy <sup>(3)</sup>         | $E_{AS}$       | 540        | mJ   |
| Power Dissipation <sup>(4)</sup>        | $P_D$          | 429        | W    |
| $T_C = 25^\circ\text{C}$                |                | 214        |      |
| Junction & Storage Temperature Range    | $T_J, T_{STG}$ | -55 to 175 | °C   |



**Electrical Characteristics (@  $T_J = 25^\circ\text{C}$  unless otherwise specified)**

| Parameter                                     | Symbol                      | Conditions   | Min. | Typ. | Max.       | Unit             |
|---|-----------------------------|--|------|------|------------|------------------|
| <b>STATIC PARAMETERS</b>                      |                             |  |      |      |            |                  |
| Drain-Source Breakdown Voltage                | $V_{(\text{BR})\text{DSS}}$ | $I_D = 250\mu\text{A}, V_{GS} = 0\text{V}$   | 150  |      |            | V                |
| Zero Gate Voltage Drain Current               | $I_{\text{DSS}}$            | $V_{DS} = 120\text{V}, V_{GS} = 0\text{V}$<br>$T_J = 55^\circ\text{C}$                     |      |      | 1.0<br>5.0 | $\mu\text{A}$    |
| Gate-Body Leakage Current                     | $I_{GSS}$                   | $V_{DS} = 0\text{V}, V_{GS} = \pm 20\text{V}$  |      |      | $\pm 100$  | nA               |
| Gate Threshold Voltage                        | $V_{GS(\text{th})}$         | $V_{DS} = V_{GS}, I_D = 250\mu\text{A}$  | 2.5  | 3.2  | 4.5        | V                |
| Static Drain-Source ON-Resistance             | $R_{DS(\text{ON})}$         | $V_{GS} = 10\text{V}, I_D = 20\text{A}$  |      | 5.2  | 6.5        | $\text{m}\Omega$ |
| Forward Transconductance                      | $g_{FS}$                    | $V_{DS} = 5\text{V}, I_D = 20\text{A}$   |      | 65   |            | S                |
| Diode Forward Voltage                         | $V_{SD}$                    | $I_S = 1\text{A}, V_{GS} = 0\text{V}$  |      | 0.71 | 1.0        | V                |
| Diode Continuous Current                      | $I_S$                       | $T_c = 25^\circ\text{C}$   |      |      | 429        | A                |
| <b>DYNAMIC PARAMETERS<sup>(5)</sup></b>       |                             |  |      |      |            |                  |
| Input Capacitance                             | $C_{iss}$                   | $V_{GS} = 0\text{V}, V_{DS} = 75\text{V}, f = 1\text{MHz}$                                 |      | 4320 |            | pF               |
| Output Capacitance                            | $C_{oss}$                   |  |      | 535  |            | pF               |
| Reverse Transfer Capacitance                  | $C_{rss}$                   |  |      | 7.2  |            | pF               |
| Gate Resistance                               | $R_g$                       | $V_{GS} = 0\text{V}, V_{DS} = 0\text{V}, f = 1\text{MHz}$                                  |      | 2.1  |            | $\Omega$         |
| <b>SWITCHING PARAMETERS<sup>(5)</sup></b>     |                             |  |      |      |            |                  |
| Total Gate Charge (@ $V_{GS} = 10\text{V}$ )  | $Q_g$                       | $V_{GS} = 0 \text{ to } 10\text{V}$<br>$V_{DS} = 75\text{V}, I_D = 20\text{A}$             |      | 68   |            | nC               |
| Total Gate Charge (@ $V_{GS} = 6.0\text{V}$ ) | $Q_g$                       |  |      | 43   |            | nC               |
| Gate Source Charge                            | $Q_{gs}$                    |  |      | 15   |            | nC               |
| Gate Drain Charge                             | $Q_{gd}$                    |  |      | 14   |            | nC               |
| Turn-On DelayTime                             | $t_{D(\text{on})}$          | $V_{GS} = 10\text{V}, V_{DS} = 75\text{V}$<br>$R_L = 3.75\Omega, R_{\text{GEN}} = 6\Omega$ |      | 18.5 |            | ns               |
| Turn-On Rise Time                             | $t_r$                       |  |      | 30   |            | ns               |
| Turn-Off DelayTime                            | $t_{D(\text{off})}$         |  |      | 53   |            | ns               |
| Turn-Off Fall Time                            | $t_f$                       |  |      | 41   |            | ns               |
| Body Diode Reverse Recovery Time              | $t_{rr}$                    | $I_F = 15\text{A}, dI_F/dt = 100\text{A}/\mu\text{s}$                                      |      | 100  |            | ns               |
| Body Diode Reverse Recovery Charge            | $Q_{rr}$                    | $I_F = 15\text{A}, dI_F/dt = 100\text{A}/\mu\text{s}$                                      |      | 150  |            | nC               |

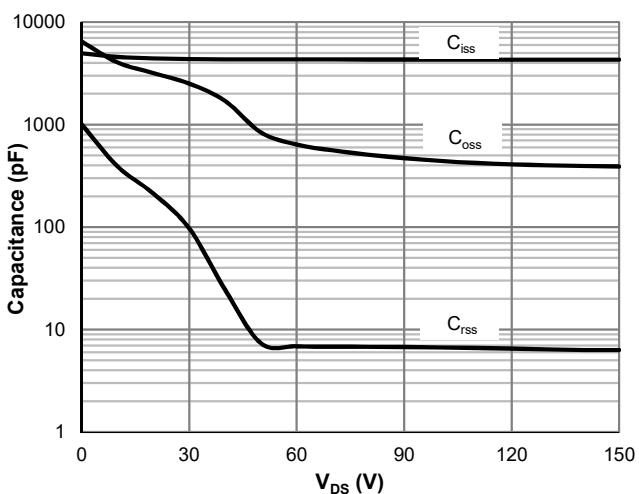
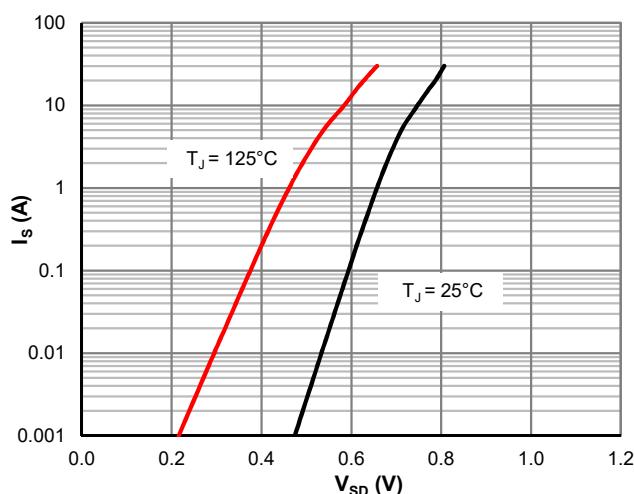
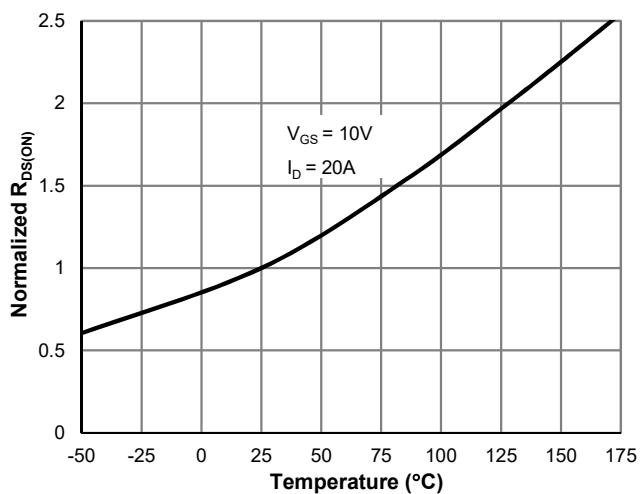
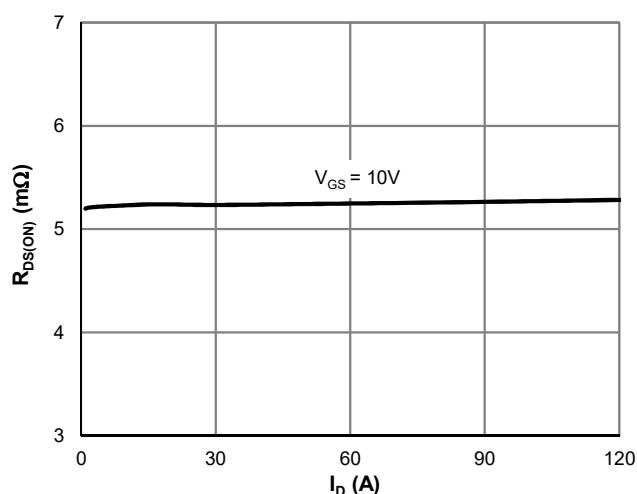
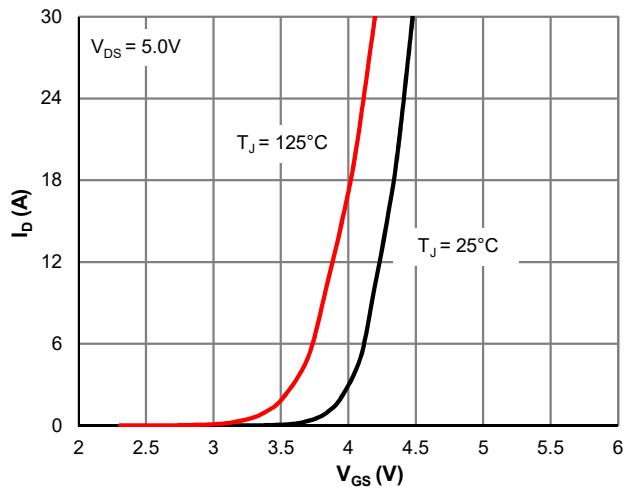
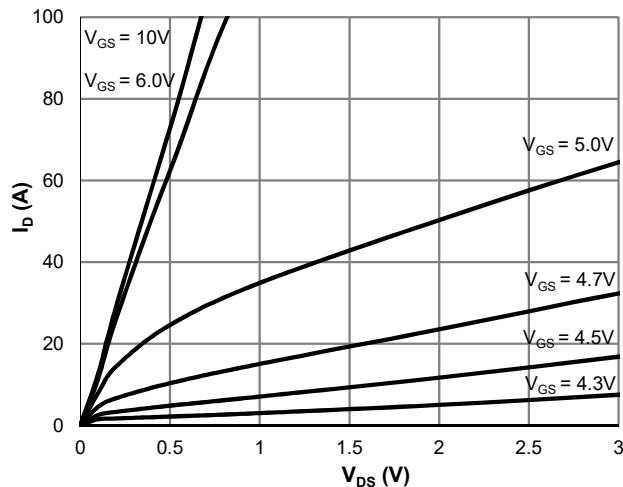
**Thermal Performance**

| Parameter                               | Symbol          | Typ. | Max. | Unit               |
|---|-----------------|------|------|--------------------|
| Thermal Resistance, Junction-to-Ambient | $R_{\theta JA}$ | 38   | 46   | $^\circ\text{C/W}$ |
| Thermal Resistance, Junction-to-Case    | $R_{\theta JC}$ | 0.35 | 0.42 | $^\circ\text{C/W}$ |

**Notes:**

1. Computed continuous current assumes the condition of  $T_{J\_Max}$  while the actual continuous current depends on the thermal & electro-mechanical application board design.
2. This single-pulse measurement was taken under  $T_{J\_Max} = 175^\circ\text{C}$ .
3. This single-pulse measurement was taken under the following condition [ $L = 300\mu\text{H}, V_{GS} = 10\text{V}, V_{DS} = 75\text{V}$ ] while its value is limited by  $T_{J\_Max} = 175^\circ\text{C}$ .
4. The power dissipation  $P_D$  is based on  $T_{J\_Max} = 175^\circ\text{C}$ .
5. This value is guaranteed by design hence it is not included in the production test.

### Typical Electrical & Thermal Characteristics



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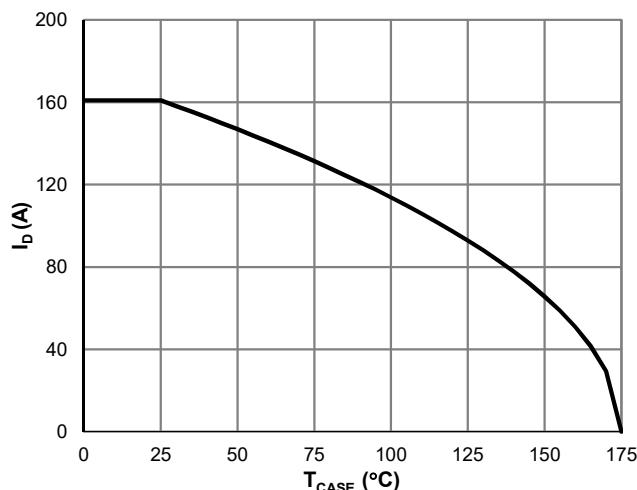


Figure 7: Current De-rating

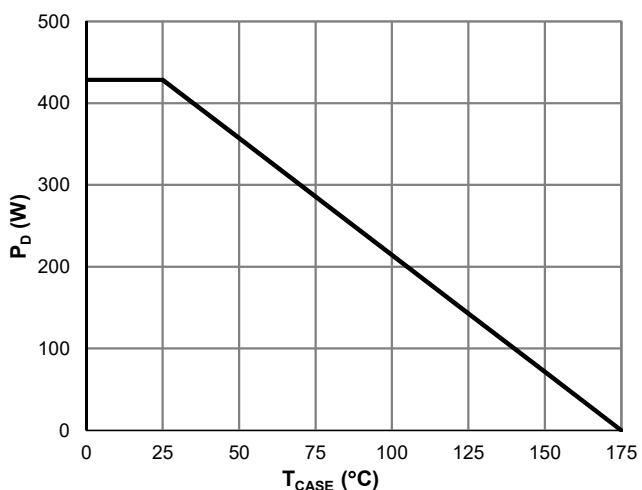


Figure 8: Power De-rating

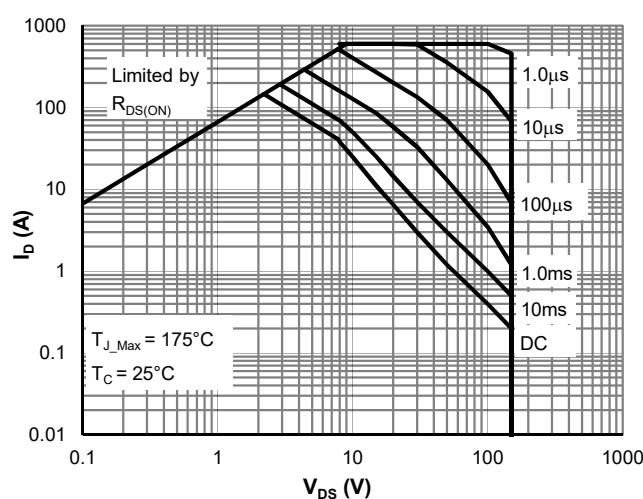


Figure 9: Maximum Safe Operating Area

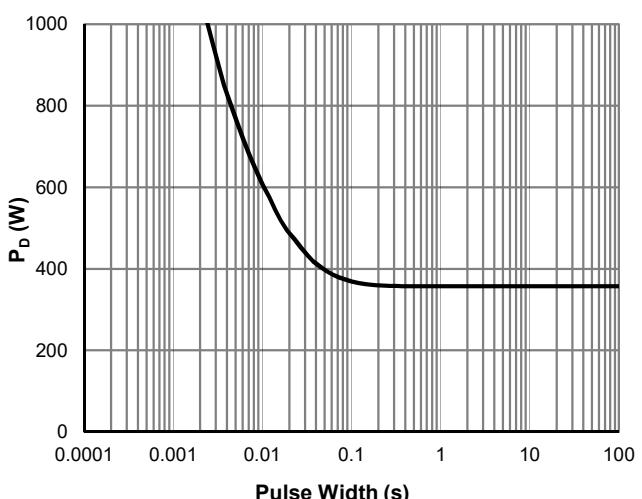


Figure 10: Single Pulse Power Rating, Junction-to-Case

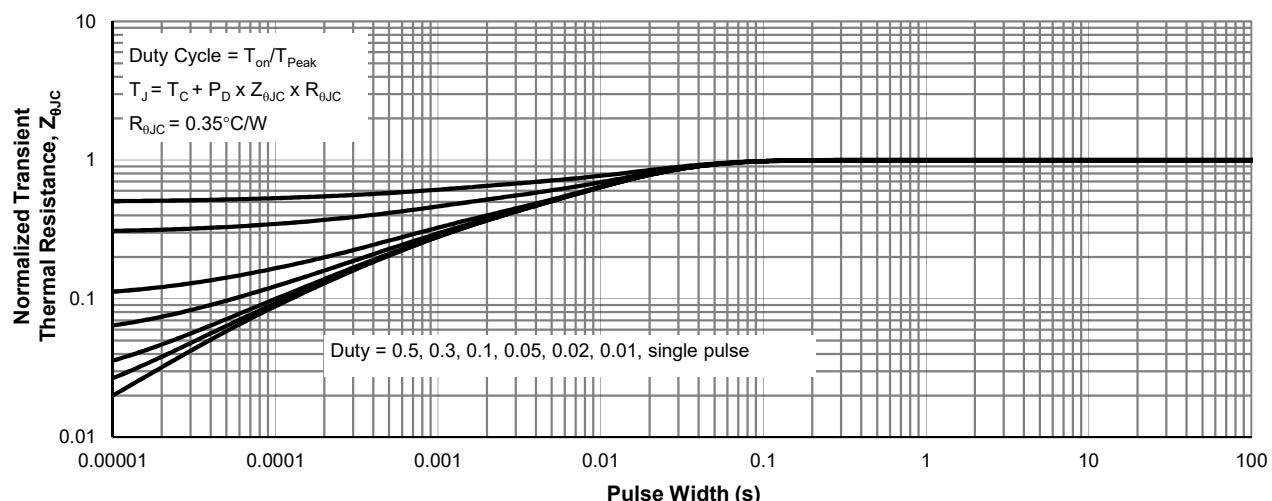
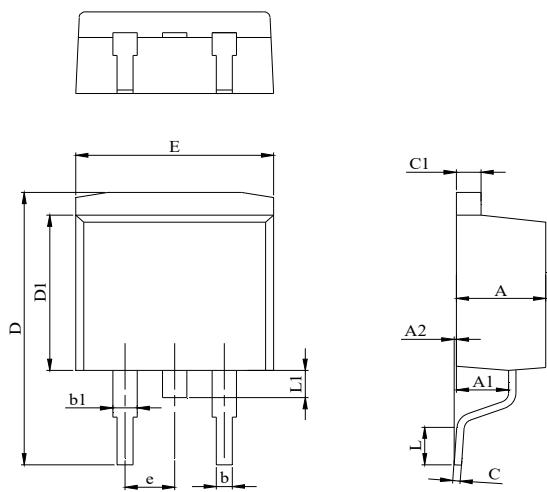


Figure 11: Normalized Maximum Transient Thermal Impedance

## TO-263-3L Package Information

## Package Outline



| DIM. | MILLIMETER |      |       |
|------|------------|------|-------|
|      | MIN.       | NOM. | MAX.  |
| A    | 4.24       |      | 4.77  |
| A1   | 2.30       |      | 2.89  |
| A2   | 0.00       | 0.10 | 0.25  |
| b    | 0.70       |      | 0.96  |
| b1   | 1.17       |      | 1.70  |
| C    | 0.30       |      | 0.60  |
| C1   | 1.15       |      | 1.42  |
| D    | 14.10      |      | 15.88 |
| D1   | 8.50       |      | 9.60  |
| E    | 9.78       |      | 10.36 |
| L    | 1.78       |      | 2.79  |
| L1   |            |      | 1.75  |
| e    |            | 2.54 |       |

## Recommend Soldering Footprint

